SDLS111 - MARCH 1974 - REVISED MARCH 1988

Blanking Input

'LS49

feature

Open-Collector Outputs

'46A, '47A, 'LS47 feature

- **Open-Collector Outputs Drive Indicators Directly**
- Lamp-Test Provision
- Leading/Trailing Zero Suppression
- Lamp-Test Provision

'48, 'LS48

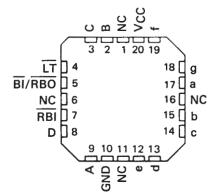
feature

Internal Pull-Ups Eliminate

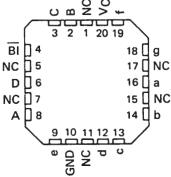
Need for External Resistors

 Leading/Trailing Zero Suppression

> SN54LS47, SN54LS48 . . . FK PACKAGE (TOP VIEW)

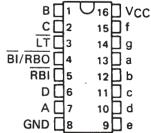


SN54LS49 . . . FK PACKAGE (TOP VIEW)

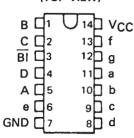


NC - No internal connection

SN5446A, SN5447A, SN54LS47, SN5448. SN54LS48 . . . J PACKAGE SN7446A, SN7447A, SN7448 . . . N PACKAGE SN74LS47, SN74LS48 . . . D OR N PACKAGE (TOP VIEW)



SN54LS49 . . . J OR W PACKAGE SN74LS49 . . . D OR N PACKAGE (TOP VIEW)



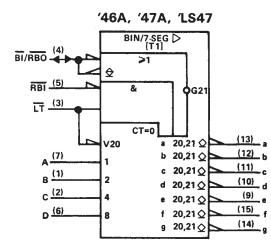
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

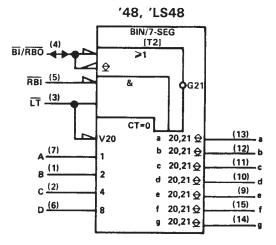


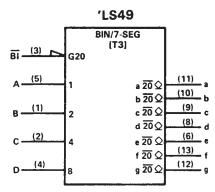
		DRIVER O	UTPUTS		TYPICAL	
TYPE	ACTIVE	OUTPUT	SINK	MAX	POWER	PACKAGES
	LEVEL	CONFIGURATION	CURRENT	VOLTAGE	DISSIPATION	
SN5446A	low	open-collector	40 mA	30 V	320 mW	J, W
SN5447A	low	open-collector	40 mA	15 V	320 mW	J, W
SN5448	high	2-kΩ pull-up	6.4 mA	5.5 V	265 mW	J,W
SN54LS47	low	open-collector	12 mA	15 V	35 mW	J, W
SN54LS48	high	2-kΩ pull-up	2 mA	5.5 V	125 mW	J, W
SN54LS49	high	open-collector	4 mA	5.5 V	40 mW	J, W
SN7446A	low	open-collector	40 mA	30 V	320 mW	J, N
SN7447A	low	open-collector	40 mA	15 V	320 mW	J, N
SN7448	high	2-kΩ pull-up	6.4 mA	5.5 V	265 mW	J, N
SN74LS47	low	open-collector	24 mA	15 V	35 mW	J, N
SN74LS48	high	2-kΩ pull-up	6 mA	5.5 V	125 mW	J, N
SN74LS49	high	open-collector	8 mA	5.5 V	40 mW	J, N

• All Circuit Types Feature Lamp Intensity Modulation Capability

logic symbols[†]







[†]These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.



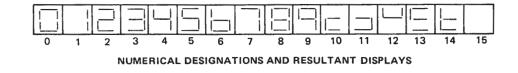
description

The '46A, '47A, and 'LS47 feature active-low outputs designed for driving common-anode LEDs or incandescent indicators directly. The '48, 'LS48, and 'LS49 feature active-high outputs for driving lamp buffers or common-cathode LEDs. All of the circuits except 'LS49 have full ripple-blanking input/output controls and a lamp test input. The 'LS49 circuit incorporates a direct blanking input. Segment identification and resultant displays are shown below. Display patterns for BCD input counts above 9 are unique symbols to authenticate input conditions.

The '46A, '47A, '48, 'LS47, and 'LS48 circuits incorporate automatic leading and/or trailing-edge zero-blanking control (\overline{RBI} and \overline{RBO}). Lamp test (\overline{LT}) of these types may be performed at any time when the $\overline{BI}/\overline{RBO}$ node is at a high level. All types (including the '49 and 'LS49) contain an overriding blanking input (\overline{BI}), which can be used to control the lamp intensity by pulsing or to inhibit the outputs. Inputs and outputs are entirely compatible for use with TTL logic outputs.

The SN54246/SN74246 and '247 and the SN54LS247/SN74LS247 and 'LS248 compose the \subseteq and the \subseteq with tails and were designed to offer the designer a choice between two indicator fonts.





SEGMENT IDENTIFICATION

DECIMAL	_		INP	JTS			BI/RBO†			0	υτρυτ	S			NOTE
FUNCTION	LT	RBI	D	С	в	Α		а	b	c	d	е	f	g	
0	н	н	L	L	L	L	н	ON	ON	ON	ON	ON	ON	OFF	
1	н	х	L	L	Ł	н	н	OFF	ON	ON	OFF	OFF	OFF	OFF	
2	н	х	L	L	н	L	н	ON	ON	OFF	ON	ON	OFF	ON	
3	н	х	L	L	н	н	н	ON	ON	ON	ON	OFF	OFF	ON	
4	н	Х	L	н	L	L	н	OFF	ON	ON	OFF	OFF	ON	ON	
5	н	х	L	н	L	н	н	ON	OFF	ON	ON	OFF	ON	ON	
6	н	x	L	н	н	Ĺ	н	OFF	OFF	ON	ON	ON	ON	ON	
7	н	X	L	н	н	н	н	ON	ON	ON	OFF	OFF	OFF	OFF	1
8	н	Х	н	L	L	L	н	ON	ON	ON	ON	ON	ON	ON	'
9	н	x	н	L	L	н	н	ON	ON	ON	OFF	OFF	ON	ON	
10	н	x	н	L	н	L	н	OFF	OFF	OFF	ON	ON	OFF	ON	
11	н	x	н	L	н	н	н	OFF	OFF	ON	ON	OFF	OFF	ON	
12	н	X	н	н	L	L	н	OFF	ON	OFF	OFF	OFF	ON	ON	
13	н	X	н	н	L	н	н	ON	OFF	OFF	ON	OFF	ON	ON	
14	н	x	н	н	н	L	н	OFF	OFF	OFF	ON	ON	ON	ON	
15	н	x	н	н	н	н	н	OFF	OFF	OFF	OFF	OFF	OFF	OFF	
81	×	X	х	х	х	X	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	2
RBI	н	L	L	L	L	L	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	3
LT	L	x	x	х	х	х	н	ON	ON	ON	ON	ON	ON	ON	4

'46A, '47A, 'LS47 FUNCTION TABLE (T1)

H = high level, L = low level, X = irrelevant

NOTES: 1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple blanking input (RBI) must be open or high if blanking of a decimal zero is not desired.

2. When a low logic level is applied directly to the blanking input (BI), all segment outputs are off regardless of the level of any other input.

3. When ripple-blanking input (RBI) and inputs A, B, C, and D are at a low level with the lamp test input high, all segment outputs go off and the ripple-blanking output (RBO) goes to a low level (response condition).

4. When the blanking input/ripple blanking output (BI/RBO) is open or held high and a low is applied to the lamp-test input, all segment outputs are on.

 $^{\dagger}\overline{\text{BI}/\text{RBO}}$ is wire AND logic serving as blanking input ($\overline{\text{BI}}$) and/or ripple-blanking output ($\overline{\text{RBO}}$).



SDLS111 - MARCH 1974 - REVISED MARCH 1988

												_			
DECIMAL			INPL	JTS			BI/RBO†			οι	JTPU	rs			NOTE
FUNCTION	LT	RBI	D	С	В	A		а	b	c _	d	е	f	_ <u>g</u>	
0	н	н	L	L	L,	L	н	Н	Н	н	Н	н	н	L	
1	н	X	L	L	L	н	н	L	н	н	L	L	L	L	
2	н	X	L	L	н	L	н	н	н	L	н	н	L	н	
3	н	X	L	L	н	н	н	Н	н	Н	Н	L	L	н	
4	н	X	L	н	L	L	н	L	н	Н	L	L	н	н	
5	н	x	L	н	L	н	н	н	L	н	н	L	н	- H	
6	н	X	L	н	н	L	н	L	L	н	н	н	н	н	
7	н	X	L	н	н	Н	н	н	н	Н	L	L	L	L	1
8	н	X	н	L	L	L	н	н	Н	Н	н	Н	н	н	•
9	н	X	н	L	L	н	н	н	н	н	L	L	н	н	
10	н	X	н	L	н	L	н	L	L	L	н	н	L	н	
11	н	X	н	L	н	Н	н	L	L	Н	н	L	L	Н	
12	н	X	н	Н	L	L	н	L	Н	L	L	L	н	н	
13	н	X	н	н	L	н	н	н	L	L	н	E -	н	н	
14	н	X	н	н	н	L	н	L	L	L	н	н	н	н	
15	н	X	н	н	н	Н	н	L	L	L	L	L	L	L	
BI	X	X	X	Х	Х	Х	L	L	L	L	L	L	L	L	2
RBI	н	L	L .	L	L	L	L L	L	L	L	L	L	L	L	3
LT	L	X	X	х	х	X	н	н	н	Н	H	Н	H	н	4

'48, 'LS48 **FUNCTION TABLE (T2)**

H = high level, L = low level, X = irrelevant

NOTES: 1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple-blanking input (RBI) must be open or high, if blanking of a decimal zero is not desired.

2. When a low logic level is applied directly to the blanking input (BI), all segment outputs are low regardless of the level of any other input.

3. When ripple-blanking input (RBI) and inputs A, B, C, and D are at a low level with the lamp-test input high, all segment outputs go low and the ripple-blanking output (RBO) goes to a low level (response condition).

4. When the blanking input/ripple-blanking output (BI/RBO) is open or held high and a low is applied to the lamp-test input, all segment outputs are high.

+BI/RBO is wire-AND logic serving as blanking input (\overline{BI}) and/or ripple-blanking output (\overline{RBO}).

				FUN	стю	N TA	BLE	(T3)					
DECIMAL		11	IPUT	s				οι	JTPU	тѕ			NOTE
FUNCTION	D	С	в	Α	BĪ	а	b	С	d	e	f	g	
0	L	L	L	L	н	н	Н	н	Н	Н	н	L	
1	L	L	L	н	H	L	Н	н	L	L	L	L	
2	L	L	н	L	н	н	н	L	н	н	L	н	
3	L	L	н	н	н	н	н	Н	Н	L	L	Н	
4	L	Н	L	L	н	L	Н	Н	L	L	н	н	
5	L	н	Ł	н	н	н	L	н	Ĥ	L	Н	н	
6	L	н	н	L	н	L	L	н	н	н	н	н	
7	L	Н	H	н	Н	н	<u> </u>	<u> </u>	L		L	<u> </u>	1
8	н	L	L	Ľ	н	н	н	н	н	Н	н	н	
9	н	L	L	н	н	н	н	н	L	L	н	н	
10	н	L	н	L	н	L	L	L	н	Н	L	Н	
11	H_	L	H	Н	н	L	L	<u> </u>	<u> </u>	L	<u> </u>	Н	
12	н	Н	L	L	н	L L	н	L	Ł	L	н	н	
13	H I	н	L	н	н	н	L	L	н	L	н	н	
14	н	н	н	L	н	L	L	L	н	н	н	н	
15	н	н	н	H	Н	L		L	<u> </u>		L	<u> </u>	
BI	X	Х	Х	Х	L	L	<u> </u>	_ L	L	L	L	L	2

'LS49 NOTION TABLE (T2)

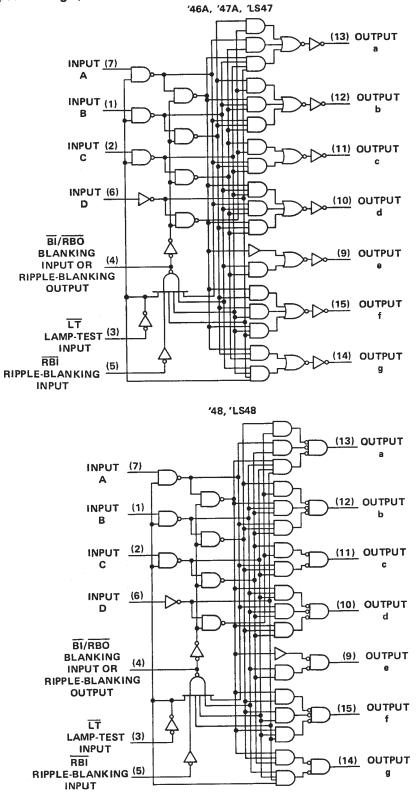
H = high level, L = low level, X = irrelevant

NOTES: 1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired.

2. When a low logic level is applied directly to the blanking input (BI), all segment outputs are low regardless of the level of any other input.



logic diagrams (positive logic)

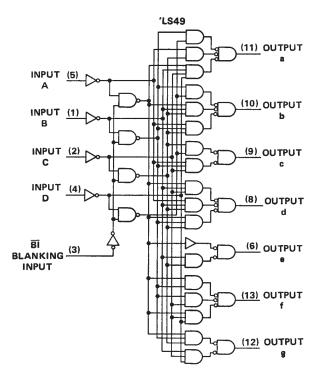


Pin numbers shown are for D, J, N, and W packages.



SN5446A, '47A, '48, SN54LS47, 'LS48, 'LS49 SN7446A, '47A, '48, SN74LS47, 'LS48, 'LS49 BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS SDLS111 – MARCH 1974 – REVISED MARCH 1988

logic diagrams (continued)

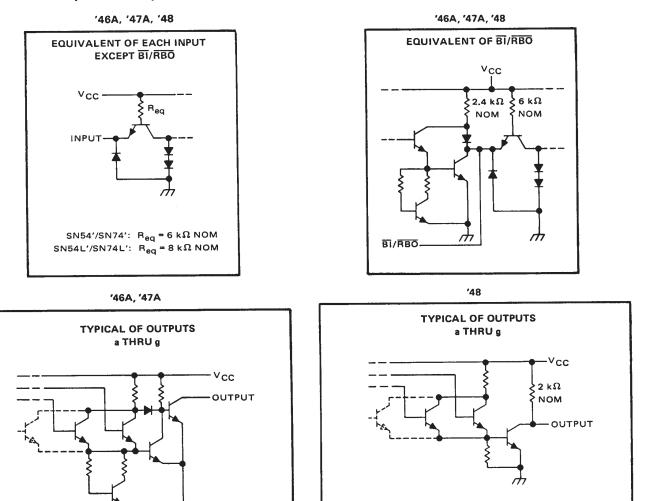


Pin numbers shown are for D, J, N, and W packages.



SN5446A, '47A, '48, SN54LS47, 'LS48, 'LS49 SN7446A, '47A, '48, SN74LS47, 'LS48, 'LS49 BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS SDLS111 – MARCH 1974 – REVISED MARCH 1988

schematics of inputs and outputs



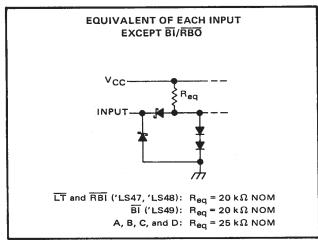


A

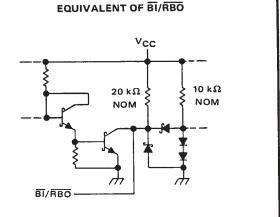
SDLS111 – MARCH 1974 – REVISED MARCH 1988

schematics of inputs and outputs

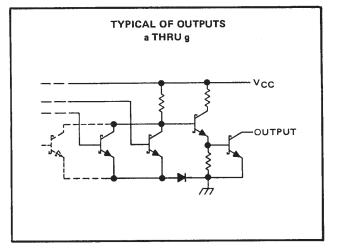
'LS47, 'LS48, 'LS49



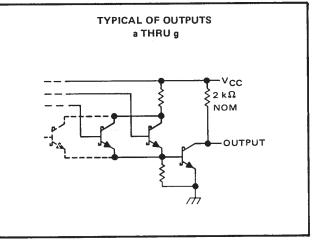
'LS47, 'LS48, 'LS49



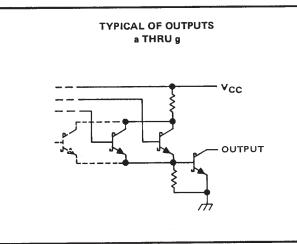
'LS47



'LS48



'LS49





SDLS111 – MARCH 1974 – REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	
Input voltage	
Current forced into any output in the off state	
Operating free-air temperature range: SN5446A, SN5447A	
SN7446A, SN7447A	$ 0^{\circ}$ C to 70 $^{\circ}$ C
Storage temperature range	65° C to 150° C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		5	SN5446A			SN5447A			N7446	Α	5	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{CC}		4.5	5	5.5	4.5	5	5.5	4.75	5	5.25	4.75	5	5.25	V
Off-state output voltage, VO(off)	a thru g			30			15			30			15	V
On-state output current, IO(on)	a thru g			40			40	1		40			40	mA
High-level output current, IOH	BI/RBO			-200			-200			-200			-200	μA
Low-level output current, IOL	BI/RBO			8			8			8			8	mA
Operating free-air temperature, T	4	-55		125	-55		125	0		70	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CONDIT	'IONS [†]	MIN	TYP‡	MAX	UNIT
∨ін	High-level input voltage	·····			2			V
VIL	Low-level input voltage						0.8	V
VIK	Input clamp voltage		V _{CC} = MIN, I _I =	—12 mA			-1.5	V
VOH	High-level output voltage	BI/RBO	V _{CC} = MIN, V _{IH} V _{IL} = 0.8 V, I _{OH}		2.4	3.7		v
V _{OL}	Low-level output voltage	BI/RBO	V _{CC} = MIN, V _{IH} V _{IL} = 0.8 V, I _{OL}	1		0.27	0.4	v
IO(off)	Off-state output current	a thru g	V _{CC} = MAX, V _{IH} V _{IL} = 0.8 V, V _O (250	μA
V _{O(on)}	On-state output voltage	a thru g	V _{CC} = MIN, V _{IH} V _{IL} = 0.8 V, I _O (c			0.3	0.4	v
ų – ¹	Input current at maximum input voltage	Any input except BI/RBO	V _{CC} = MAX, V _I =	• 5.5 V			1	mA
۱н	High-level input current	Any input except BI/RBO	V _{CC} = MAX, V ₁ =	= 2.4 V			40	μA
μL	Low-level input current	Any input except BI/RBO	V _{CC} = MAX, V _I =	= 0.4 V			-1.6	mA
		BI/RBO]				4	
IOS	Short-circuit output current	BI/RBO	V _{CC} = MAX				-4	mA
100	Supply current	<u> </u>	V _{CC} = MAX,	SN54'		64	85	mA
ICC	ouppiy ourient		See Note 2	SN74'		64	103	

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT
toff	Turn-off time from A input			100	ns
ton	Turn-on time from A input	$C_{L} = 15 pF, R_{L} = 120 \Omega,$		100	
toff	Turn-off time from RBI input	See Note 3		100	ns
ton	Turn-on time from RBI input			100	113

SDLS111 - MARCH 1974 - REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)						 								7V
Input voltage						 								5.5 V
Operating free-air temperature range: SN	5448					 								–55°C to 125°C
SN	7448					 								. 0°C to 70°C
Storage temperature range		•	•			 	•	•	•	•	•	•	•	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN5448	3		UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
	a thru g	1		400			-400	μA
High-level output current, IOH	BI/RBO			-200			200	
	a thru g			6.4			6.4	mA
Low-level output current, IOL	BI/RBO			8			8	
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CONI	DITIONS	MIN	TYP‡	MAX	UNIT
⊻ін	High-level input voltage				2			V
VIL	Low-level input voltage						0.8	V
VIK	Input clamp voltage		V _{CC} = MIN, I	=12 mA			-1.5	V
V _{OH}	High-level output voltage	a thru g BI/RBO	V _{CC} = MIN, V V _{II} = 0.8 V, I _C		2.4 2.4	4.2		v
10	Output current	a thru g	V _{CC} = MIN, V Input conditions	-	-1.3	2		mA
VOL	Low-level output voltage		V _{CC} = MIN, V V _{IL} = 0.8 V, I _C			0.27	0.4	v
ų	Input current at maximum input voltage	Any input except BI/RBO	V _{CC} = MAX, V	1 = 5.5 V			1	mA
Чн	High-level input current	Any input except BI/RBO	V _{CC} = MAX, V	′ _I = 2.4 ∨			40	μA
ηL	Low-level input current	Any input except BI/RBO BI/RBO	V _{CC} = MAX, V	′I = 0.4 V			-1.6	mA
los	Short-circuit output current	BI/RBO	V _{CC} = MAX				-4	
lcc	Supply current	• • • • • • • • • • • • • • • • • • •	V _{CC} = MAX, See Note 2	SN5448 SN7448		53 53	76 90	-l mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

NOTE 2: ICC is measured with all outputs open and all inputs at 4.5 V.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25 °C$

PARAMETER	TEST CONDITIONS	MIN	түр	MAX	UNIT
^t PHL Propagation delay time, high-to-low-level output from A input				100	ns
tPLH Propagation delay time, low-to-high-level output from A input	$C_{L} = 15 \text{ pF}, R_{L} = 1 \text{ k}\Omega$			100	
tPHL Propagation delay time, high-to-low-level output from RBI input	See Note 3			100	ns
^t PLH Propagation delay time, low-to-high-level output from RBI input				100	

SDLS111 – MARCH 1974 – REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)			 											7 V
Input voltage		•	 											7 V
Peak output current ($t_W \le 1$ ms, duty cycle $\le 10\%$)	J												200) mA
Current forced into any output in the off state .														1 mA
Operating free-air temperature range: SN54LS47											-55	°C	to 1	25°C
SN74LS47			 									0°0	C to	70°C
Storage temperature range			 •								-65	°C	to 1	50°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		S	N54LS4	17	S	SN74LS47				
		MIN	NOM	MAX	MIN	NOM	MAX	דואט		
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V		
Off-state output voltage, VO(off)	a thru g			15	<u> </u>		15	V		
On-state output current, IO(on)	a thru g			12			24	mA		
High-level output current, IOH	BI/RBO			-50			-50	μA		
Low-level output current, IOL	BI/RBO			1.6			3.2	mA		
Operating free-air temperature, TA		-55		125	0		70	°c		

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					c	N54LS4	17	-	N74LS4	17	
	PARAMETER		TEST CON	IDITIONS [†]	MIN		MAX	MIN		MAX	UNIT
VIH	High-level input voltage				2	117+		2	110+	IVIAX	
VIL	Low-level input voltage				~		0.7	<u> </u>		0.8	V
VIK	Input clamp voltage		V _{CC} = MIN,	I _I = -18 mA			-1.5			-1.5	v
v _{он}	High-level output voltage	BI/RBO	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} ≈ 2 V,	2.4	4.2		2.4	4.2		v
VOL	Low-level output voltage	BI/RBO	V _{CC} = MIN, V _{IH} = 2 V,	l _{OL} = 1.6 mA		0.25	0.4		0.25	0.4	v
	_on or of the the total go	51,1100	VIL = VIL max	I _{OL} = 3.2 mA					0.35	0.5	
lO(off)	Off-state output current	a thru g	V _{CC} = MAX, V _{IL} = V _{IL} max,	V _{IH} = 2 V, V _{O(off)} = 15 V			250			250	μA
V _{O(on)}	On-state output voltage	a thru q	V _{CC} = MIN, V _{IH} = 2 V,	l _{O(on)} = 12 mA		0.25	0.4		0.25	0.4	v
0(01)			VIL = VIL max	¹ O(on) = 24 mA					0.35	0.5	
II.	Input current at maximur	n input voltage	V _{CC} = MAX,	V _I = 7 V			0.1			0.1	mA
IIН	High-level input current		V _{CC} = MAX,	V ₁ = 2.7 V			20			20	μA
կլ	Low-level input current	Any input except BI/RBO	V _{CC} = MAX,	V _I = 0.4 V			-0.4			-0.4	mA
		BI/RBO					-1.2			-1.2]
IOS	Short-circuit output current	BI/RBO	V _{CC} = MAX		-0.3		-2	-0.3		-2	mA
ICC	Supply current		V _{CC} = MAX,	See Note 2		7	13		7	13	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V. switching characteristics, $V_{CC} = 5 V$, $T_A = 25 °C$

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
toff	Turn-off time from A input				100	
ton	Turn-on time from A input	$C_{L} = 15 pF, R_{L} = 665 \Omega,$			100	ns
toff	Turn-off time from RBI input, outputs (a-f) only	See Note 3			100	
ton	Turn-on time from RBI input, outputs (a-f) only				100	ns



SDLS111 – MARCH 1974 – REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	 1 V
Input voltage	 1 V
Operating free-air temperature range: SN54LS48	 5°C
SN74LS48	 JC
	 °C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		s	N54LS4	8	S	דואט		
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
	a thru g			-100			-100	μA
High-level output current, IOH	BI/RBO			-50			-50	μ <i>μ</i> Α
· · · · · · · · · · · · · · · · · · ·	a thru g			2			6	mA
Low-level output current, IOL	BI/RBO			1.6			3.2	
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				DITIONIST	S	N54LS4	8	S	N74LS4	8	UNIT
	PARAMETER		TEST CON	DITIONS	MIN	түр‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage		V _{CC} = MIN,	l ₁ = -18 mA			-1.5			-1.5	V
V _{OH}	High-level output voltage	a thru g and BI/RBO	V _{CC} = MIN, V _{IL} = V _{IL} max,		2.4	4.2		2.4	4.2		v
1 ₀	Output current	a thru g	V _{CC} = MIN, Input conditions	$V_{O} = 0.85 V$, as for V_{OH}	-1.3	-2	-	-1.3	-2		mA
			$V_{CC} = MIN,$	1 _{0L} = 2 mA		0.25	0.4		0.25	0.4	
	1	a thru g	V _{IH} = 2 V, V _{IL} = V _{IL} max	IOL = 6 mA					0.35	0.5	
VOL	Low-level output voltage	BI/RBO	$V_{CC} = MIN,$	I _{OL} = 1.6 mA		0.25	0.4		0.25	0.4	
		ыльо	V _{IH} = 2 V, V _{IL} = V _{IL} max	I _{OL} = 3.2 mA					0.35	0.5	
4	Input current at maximum input voltage	Any input except BI/BRO	V _{CC} = MAX,	V ₁ = 7 V			0.1			0.1	mA
ін	High-level input current	Any input except BI/RBO	V _{CC} = MAX,	V _I = 2.7 V			20			20	μA
μL	Low-level input current	Any input except BI/RBO	V _{CC} = MAX,	V ₁ = 0.4 V			-0.4			-0.4	mA
		BI/RBO		-			-1.2			-1.2]
Ios	Short-circuit output current	BI/RBO	V _{CC} = MAX		-0.3		-2	-0.3		-2	
1cc	Supply current		V _{CC} = MAX,	See Note 2		25	38		25	38	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A 25°C.

NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

switching characteristics,	$V_{CC} =$	5 V, TA	= 25°C
----------------------------	------------	---------	--------

PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
^t PHL Propagation delay time, high-to-low-level output from A input	$C_{L} = 15 \text{ pF}, R_{L} = 4 \text{ k}\Omega,$			100	ns
tpLH Propagation delay time, low-to-high-level output from A input	See Note 3			100	113
tPHL Propagation delay time, high-to-low-level output (a-f only) from RBI input	$C_{L} = 15 \text{ pF}, R_{L} = 6 \text{ k}\Omega,$			100	ns
tPLH Propagation delay time, low-to-high-level output (a-f only) from RBI input	See Note 3			100	



SDLS111 – MARCH 1974 – REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)																			7 V
Input voltage																			7 V
Current forced into any output in the off state																			1 mA
Operation free-air temperature range: SN541 S49																55°	C t	to 1	125°C
SN741 S49																U U	JC	to	10 C
Storage temperature range	 •	-	•	 	•	-	-	•	•	•	•	-			-6	5	Ct	01	150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	s	N54LS	19	s	N74LS4	19	UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output voltage, V _{OH}			5.5			5.5	V
Low-level output current, IOL			4			8	mA
Operating free-air temperature, T _A	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST COM	DITIONS	S	N54LS4	9	S	N74LS4	19	
		TEST COM	ADITION2,	MIN	ТҮР‡	MAX	MIN	τγρ‡	MAX	UNIT
VIH	High-level input voltage			2			2			V
VIL	Low-level input voltage					0.7			0.8	V
VIK	Input clamp voltage	V _{CC} = MIN,	l _l = -18 mA			-1.5			-1.5	V
юн	High-level output current	V _{CC} = MIN, V _{1L} = V _{1L} max,	V _{IH} = 2 V, V _{OH} = 5.5 V			250			250	μА
VOL	Low-level output voltage	$V_{CC} = MIN,$ $V_{IH} = 2 V,$	1 _{0L} = 4 mA		0.25	0.4		0.25	0.4	V
		Vil = Vil max	1 _{0L} = 8 mA	-				0.35	0.5] `
Ц	Input current at maximum input voltage	V _{CC} = MAX,	V1 = 7 V			0.1			0.1	mA
ιн	High-level input current	V _{CC} = MAX,	VI = 2.7 V			20			20	μA
1IL	Low-level input current	V _{CC} = MAX,	V1 = 0.4 V			-0.4			-0.4	mA
lcc	Supply current	V _{CC} = MAX,	See Note 2		8	15		8	15	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25 °C$

PARAMETER	TEST CONDITIONS	MIN 1	ΓΥΡ ΜΑΧ	UNIT
tPHL Propagation delay time, high-to-low-level output from A input	$C_{L} = 15 \text{ pF}, R_{L} = 4 \text{ k}\Omega,$		100	
tPLH Propagation delay time, low-to-high-level output from A input	See Note 3		100	ns
tPHL Propagation delay time, high-to-low-level output (a-f only) from RBI input	$C_{L} = 15 pF, R_{L} = 6 k\Omega,$		100	
tPLH Propagation delay time, low-to-high-level output (a-f only) from RBI input	See Note 3		100	ns





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9856401QEA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9856401QE A SNJ5447AJ	Samples
5962-9856401QFA	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9856401QF A SNJ5447AW	Samples
7604501EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7604501EA SNJ54LS47J	Samples
SN5447AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5447AJ	Samples
SN54LS47J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS47J	Samples
SN54LS49J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS49J	Samples
SN7447AN	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN7447AN	Samples
SN7447ANE4	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN7447AN	Samples
SN74LS47D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS47	Samples
SN74LS47DR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM		LS47	Samples
SN74LS47N	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS47N	Samples
SN74LS47NE4	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS47N	Samples
SN74LS47NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS47	Samples
SNJ5447AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9856401QE A SNJ5447AJ	Samples
SNJ5447AW	ACTIVE	CFP	W	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9856401QF A SNJ5447AW	Samples
SNJ54LS47FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 47FK	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54LS47J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7604501EA SNJ54LS47J	Samples
SNJ54LS49J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS49J	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



www.ti.com

OTHER QUALIFIED VERSIONS OF SN5447A, SN54LS47, SN7447A, SN74LS47 :

• Catalog : SN7447A, SN74LS47

• Military : SN5447A, SN54LS47

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

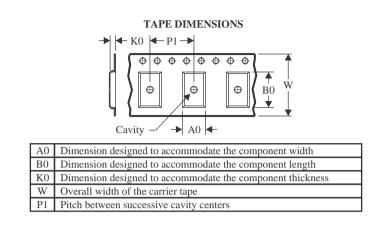


Texas

NSTRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*A	Il dimensions are nominal												
ſ	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN74LS47DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
	SN74LS47NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



www.ti.com

PACKAGE MATERIALS INFORMATION

9-Aug-2022



*All dimensions are nominal

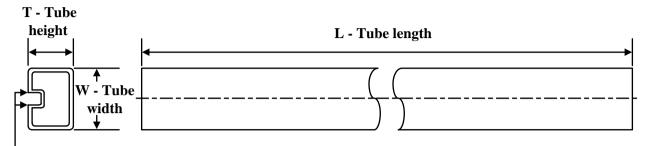
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS47DR	SOIC	D	16	2500	340.5	336.1	32.0
SN74LS47NSR	SO	NS	16	2000	356.0	356.0	35.0

TEXAS INSTRUMENTS

www.ti.com

9-Aug-2022

TUBE



- B - Alignment groove width

*All dimensions are nominal	

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
5962-9856401QFA	W	CFP	16	1	506.98	26.16	6220	NA
SN7447AN	N	PDIP	16	25	506	13.97	11230	4.32
SN7447AN	N	PDIP	16	25	506	13.97	11230	4.32
SN7447ANE4	N	PDIP	16	25	506	13.97	11230	4.32
SN7447ANE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS47D	D	SOIC	16	40	507	8	3940	4.32
SN74LS47N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS47N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS47NE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS47NE4	N	PDIP	16	25	506	13.97	11230	4.32
SNJ5447AW	W	CFP	16	1	506.98	26.16	6220	NA
SNJ54LS47FK	FK	LCCC	20	1	506.98	12.06	2030	NA

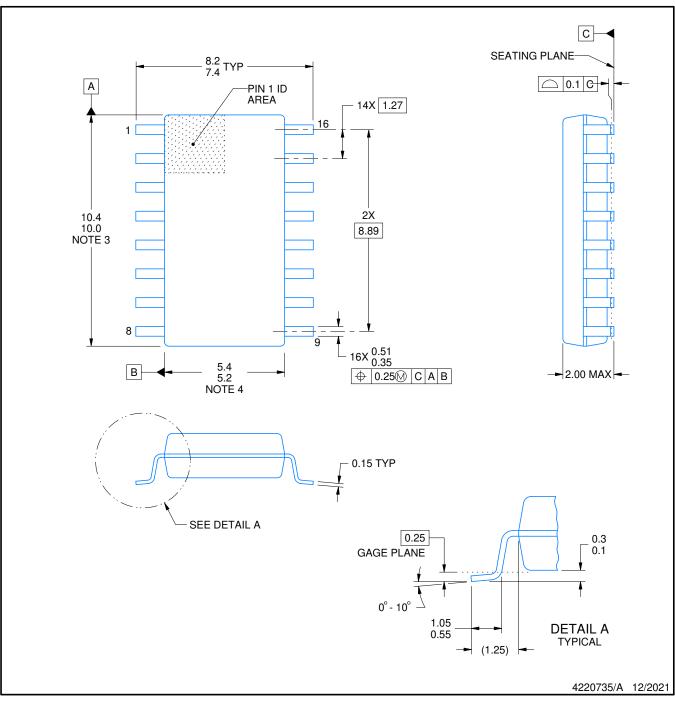
NS0016A



PACKAGE OUTLINE

SOP - 2.00 mm max height

SOP



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

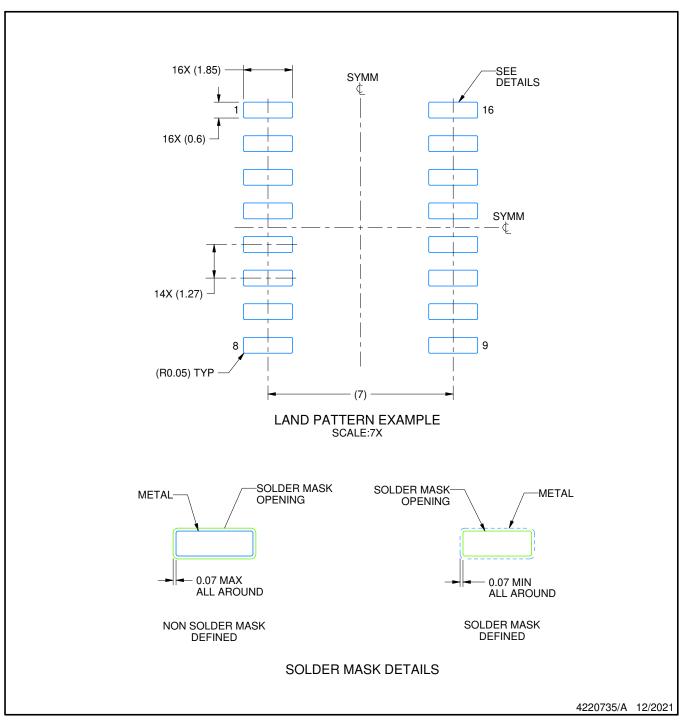


NS0016A

EXAMPLE BOARD LAYOUT

SOP - 2.00 mm max height

SOP



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

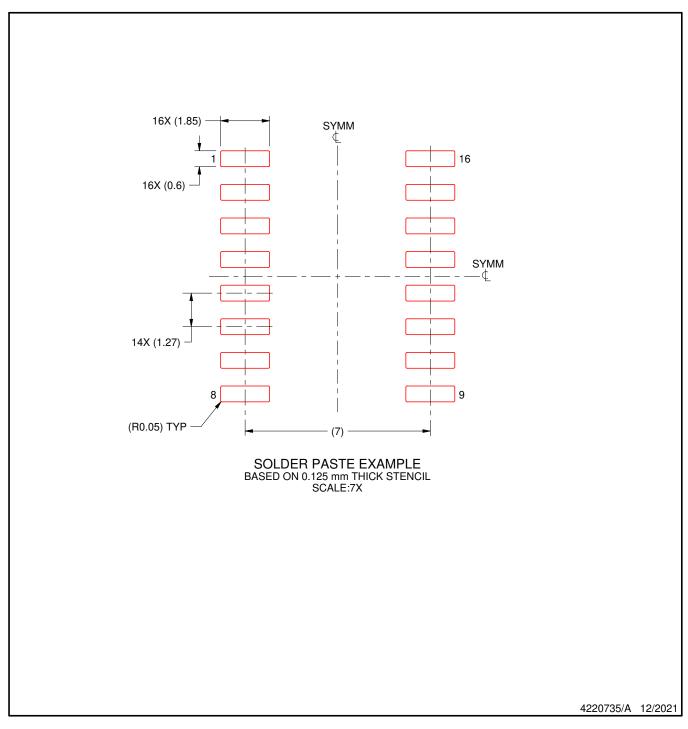


NS0016A

EXAMPLE STENCIL DESIGN

SOP - 2.00 mm max height

SOP



NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

8. Board assembly site may have different recommendations for stencil design.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



4211283-4/E 08/12

D (R-PDSO-G16) PLASTIC SMALL OUTLINE Stencil Openings (Note D) Example Board Layout (Note C) –16x0,55 -14x1,27 -14x1,27 16x1,50 5,40 5.40 Example Non Soldermask Defined Pad Example Pad Geometry (See Note C) 0,60 .55 Example 1. Solder Mask Opening (See Note E) -0,07 All Around

NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

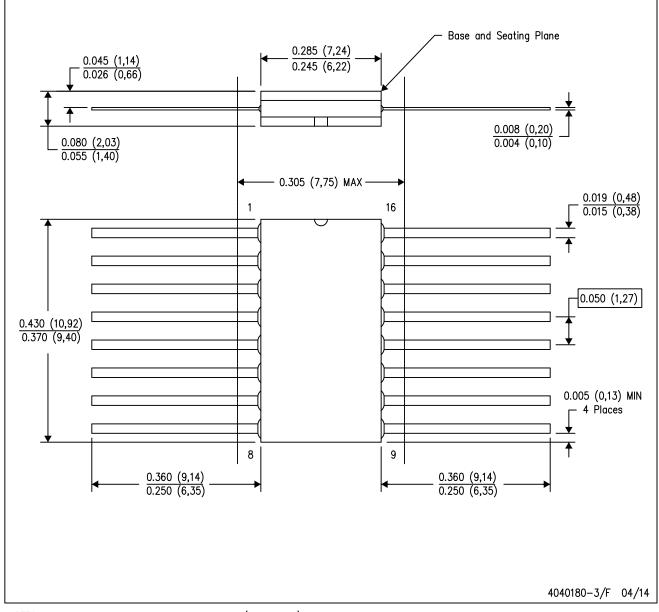
14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP2-F16



FK 20

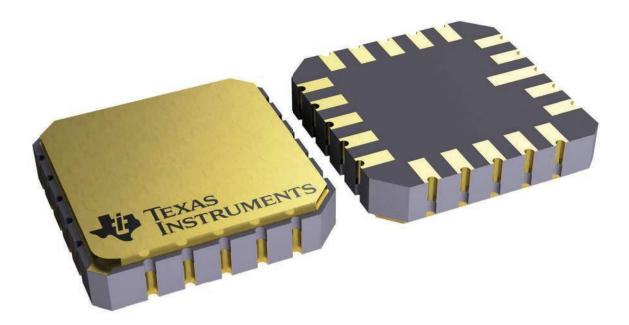
8.89 x 8.89, 1.27 mm pitch

GENERIC PACKAGE VIEW

LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



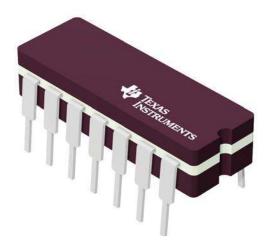
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

GENERIC PACKAGE VIEW

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



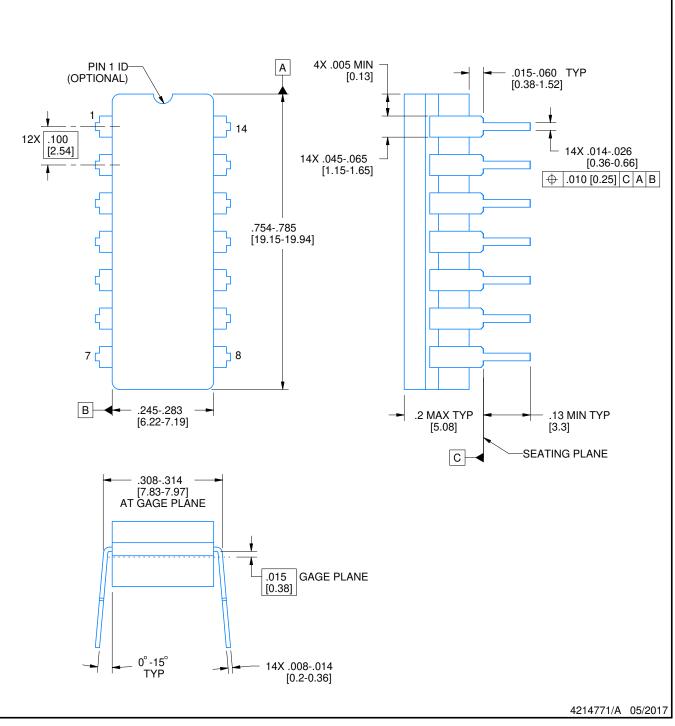
J0014A



PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.

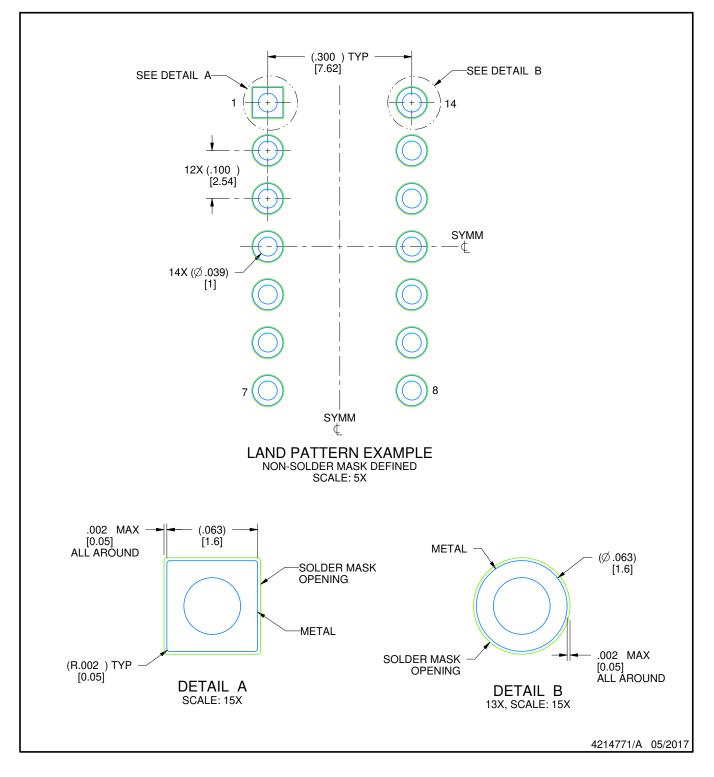


J0014A

EXAMPLE BOARD LAYOUT

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2023, Texas Instruments Incorporated